

RECEIPT  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: KELKAR et al.

Attorney Docket No.: NSC1P181/P04767

Application No.: 09/653,925

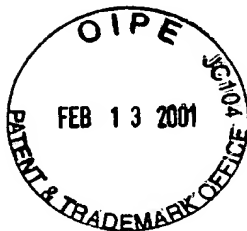
Examiner: Unknown

Filed: September 01, 2000

Group: 2811

Title: WAFER LEVEL CHIP SCALE PACKAGE

#3  
D. Scott  
519-01



CERTIFICATE OF MAILING

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Sandra Halliwell

REQUEST FOR CORRECTED FILING RECEIPT

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Enclosed is a copy of the Filing Receipt for the above-identified patent application with the following changes noted thereon:

Applicant(s)

Nikhil Vishwanath Kelkar, San Jose, CA;  
Hem P. Takiar, Fremont, CA;

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Please reprint a Corrected Filing Receipt and mail the same to the undersigned.

Since this is a Patent Office typographical error, no fee should be due. However, the Commissioner is authorized to charge any fees that may be due to Deposit Account 50-0388 (Order No.NSC1P181).

Respectfully submitted,  
BEYER WEAVER & THOMAS, LLP

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/653,925	09/01/2000	2811	690	NSC1P181/P04767	9	20	3

022434  
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## FILING RECEIPT



\*OC000000005520253\*

Date Mailed: 10/31/2000

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

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Hem P. Takiar, Fremont, CA ;

## Continuing Data as Claimed by Applicant

## Foreign Applications

If Required, Foreign Filing License Granted 10/31/2000

## Title

Wafer level chip scale package

## Preliminary Class

257

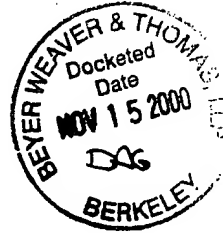
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Data entry by : MARTIN, DIANE

Team : OIPE

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